



JOEDA3AB-L5X Series

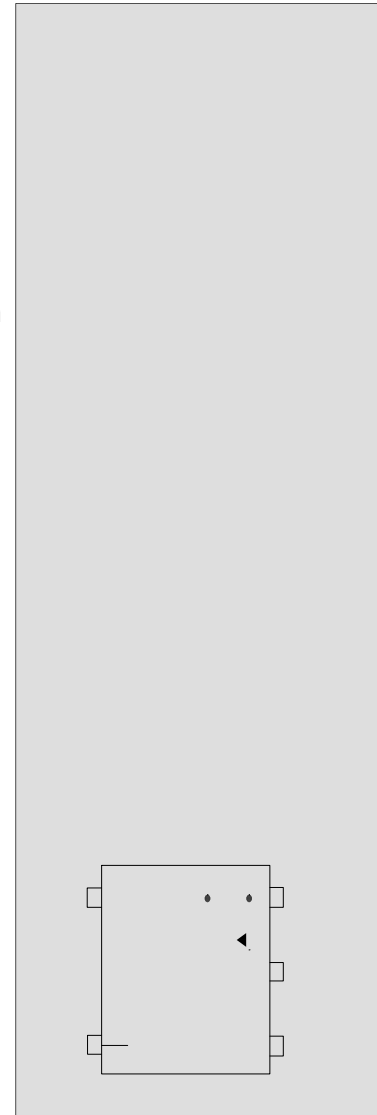
Rev.A.1.0

Overview

The products are gate driver opto-couplers in LSOP5 and LSOP5W packages. The device consists of an infrared LED optically coupled to an integrated high-gain, high-speed photodetector IC chip. It provides guaranteed performance and specifications at temperature up to 110°C. It is physically smaller and compliant with international safety standards for reinforced insulation. It thus provides a smaller footprint solution for applications that require safety standard certification. An internal noise shield provides a guaranteed common-mode transient immunity of ±35 kV/μs. It is ideal for small class IGBT and power MOSFET gate drive. The products are widely used in industrial inverters, IGBT gate drivers, MOSFET gate drivers, induction cooktop and home appliances.

Key Features

- High isolation 5000 VRMS
- Buffer logic type
- Operating temperature range -40°C to 110°C
- REACH & RoHS compliance
- HBM: H3A; MM: M4; CDM: C3
- CQC approved
- VDE approved
- UL approved



Truth Table

LED	V _{CC} -V _{EE} (Positive Going)	V _{CC} -V _{EE} (Negative Going)	Output
OFF	0-30V	0-30V	Low
ON	0-12.1V	0-11.1V	Low
ON	12.1V-13.5V	11.1V-12.4V	TRANSITION
ON	13.5V-30V	12.4V-30V	HIGH

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Parameter		Symbol	Value	Unit
LED	Forward Current	I _F	50	mA
	Peak Forward Current	I _{FP}	1	A
	Reverse Voltage	V _R	6	V
	Power Dissipation	P _D	100	mW
Detector	Output Voltage	V _O	35	V
	Supply Voltage	V _{CC}	35	V
	Power Dissipation	P _C	400	mW
Isolation Voltage		V _{iso}	5000	Vrms
Operating Temperature		T _{opr}	-40~110	
Junction Temperature		T _j	125	
Storage Temperature		T _{stg}	-55~125	
Total Power Dissipation		P _{tot}	500	mW
Soldering Temperature		T _{sol}	260	

V \ u : 100µs pulse, 100Hz frequency

V \ u : AC for 1minute, R.H.=40~60%

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Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V _F	I _F =10mA	-	1.35	1.6	V
	Reverse Current	I _R	V _R =6V	-	-	1	µA
	Terminal Capacitance	C _t	V=0, f=1MHz	-	60	-	pF
Peak High-level Output Current		I _{OPH}	V _O =V _{CC} -4V, Pulse width 50µs	-1	-	-	A
			V _O =V _{CC} -15V, Pulse width 10µs	-	-	-	A

Peak Low-level Output

Current

Output

Common Mode Transient Immunity at Low Level Output	CML	I _F =0mA V _{CC} =30V, T _a =25 , V _{O(max)} =1V V _{CM} =1000Vpp	±		-	kV/μs
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All Typical values at T_a=25

V : Input signal (f=25kHz,duty=50%, tr=tf=5ns or less). C_L is less than 15 pF which includes probe and stray wiring capacitance.

V : CM_H is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic high state (V_O = 26V).

V : CML is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic low state (V_O = 1V).

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Characteristics	Symbol	Min.	Typ.	Max.	Unit
Input On-state Current	I _{F(ON)}	6.5	-	10	mA
Input Off-state Voltage	V _{F(OFF)}	0	-	0.8	V
Supply Voltage	V _{CC}	15	-	30	V
Operating Frequency	f	-	-	25	kHz

V : The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

V : A ceramic capacitor(0.1μF) should be connected between pin 6 (V_{CC}) and pin 4 (GND) to stabilize the operation of a high gain linear amplifier. Otherwise, this photocoupler may not switch properly. The bypass capacitor should be placed within 1 cm of each pin.

V : The rise and fall times of the input on current should be less than 0.5 μs.

V : If the rising slope of the supply voltage (V_{CC}) for the detector is steep, stable operation of the internal circuits cannot be guaranteed. Be sure to set 3 V/μs or less for a rising slope of the V_{CC}.

V : Denotes the operating range, not the recommended operating condition.



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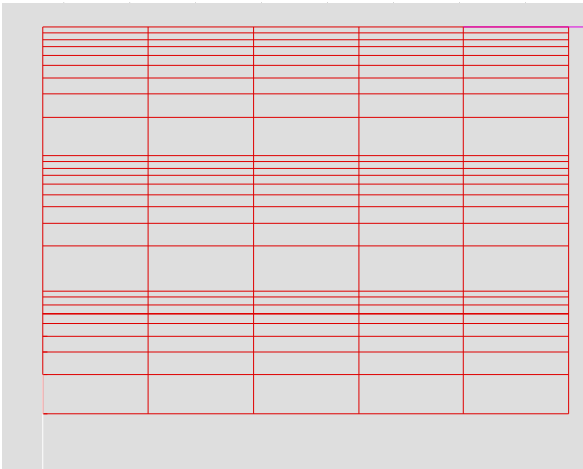
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FIG.1: Forward Current vs. Forward Voltage

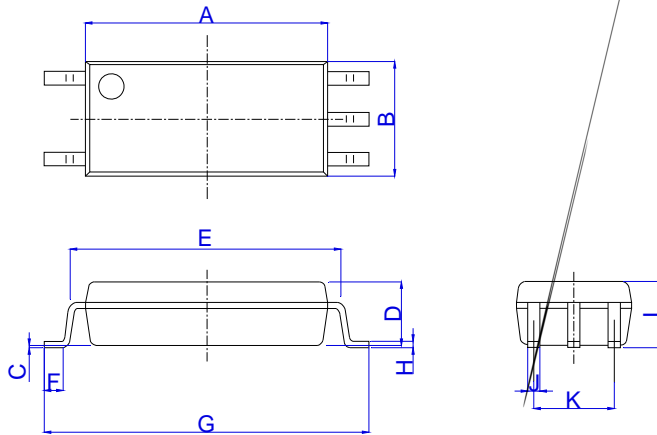
FIG.2: Max. Allowable LED Forward Current vs. Ambient Temperature





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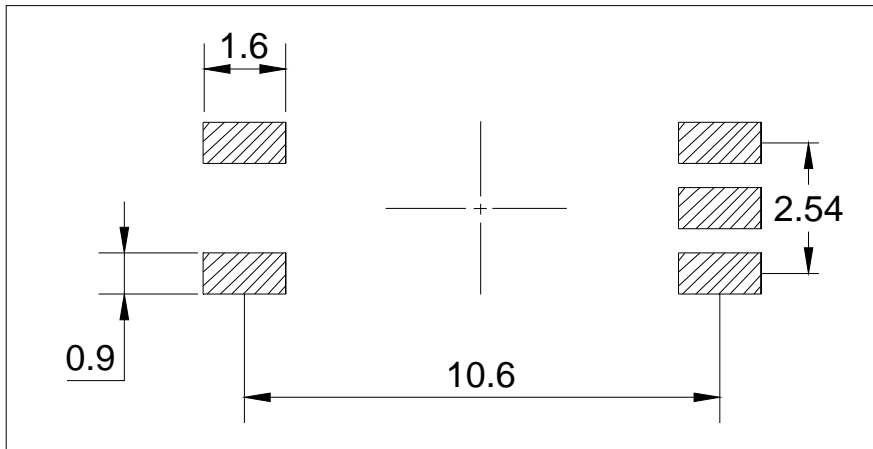
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	7.40		7.80	0.291		0.307
B	3.40		3.80	0.134		0.150
C	0.00		0.20	0.000		0.008
D	1.80		2.20	0.071		0.087
E	8.10		8.70	0.319		0.343
F	0.40		1.00	0.016		0.039
G	9.90		10.50	0.390		0.413
H	0.10		0.30	0.004		0.012
I	1.80		2.40	0.071		0.094
J	0.25		0.55	0.010		0.022
K	2.29		2.79	0.090		0.110

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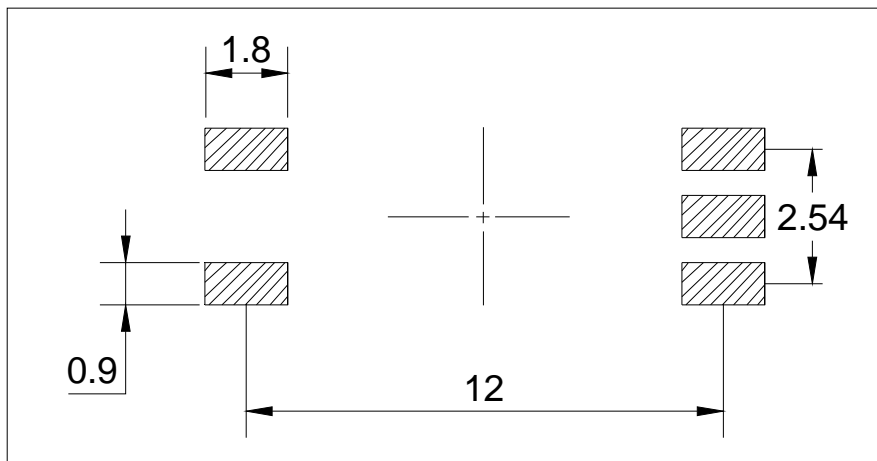


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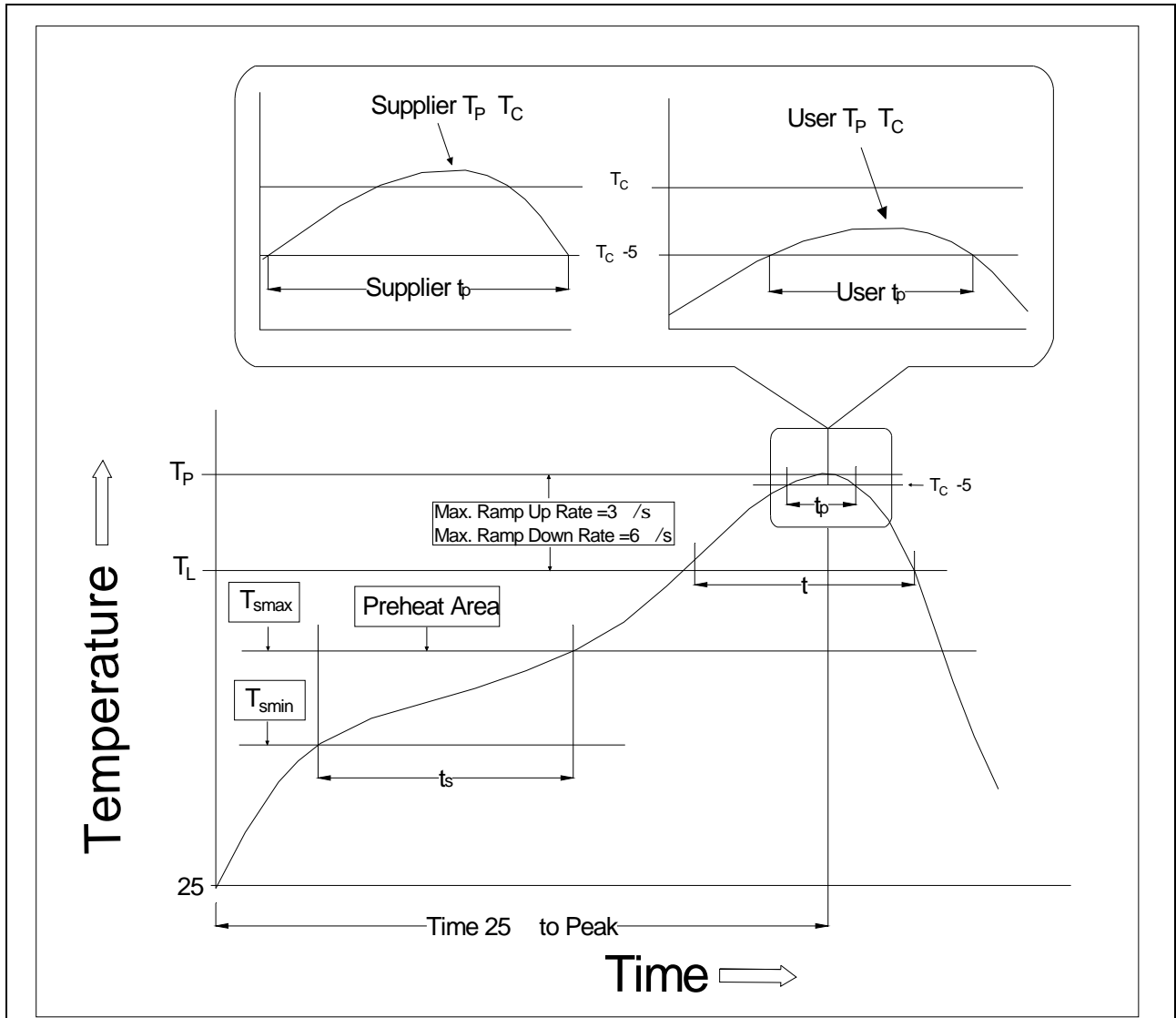
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Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150
Temperature Max. (T_{smax})	150	200
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	3 /second max.	3 /second max.
Liquidus Temperature (T_L)	183	217
Time (t_L) Maintained Above (T_L)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235 +0 /-5	260 +0 /-5
Time (t_P) within 5 of 260	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	6 /second max.	6 /second max.
Time 25 to Peak Temperature	6 minutes max.	8 minutes max.

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum